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## \*BIBDATASHEET\*

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Bib Data Sheet

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## APPLICANTS

James M. Wark, Boise, ID;

## \*\* CONTINUING DATA \*\*\*\*\*

This application is a CON of 10/156,976 05/29/2002 PAT 6,605,489  
 which is a CON of 09/642,134 08/18/2000 PAT 6,399,416  
 which is a CON of 09/390,889 09/07/1999 PAT 6,140,149  
 which is a CON of 08/914,719 08/19/1997 PAT 6,071,754  
 which is a CON of 08/752,802 11/20/1996 PAT 5,696,031

*MSL*

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

*MSL*

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 11/05/2003

Foreign Priority claimed	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY ID	SHEETS DRAWING 5	TOTAL CLAIMS 27	INDEPENDENT CLAIMS 5
35 USC 119 (a-d) conditions met	<input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	<i>EJW</i> Examiner's Signature	Initials			

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## TITLE

Methods for stacking wire-bonded integrated circuit dice on flip-chip bonded integrated circuit dice

FILING FEE	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees ( Filing ) <input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) <input type="checkbox"/> 1.18 Fees ( Issue )
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